



RE936-03

- Multiadapter TSOP 56 & HTSOP56
- Epoxy fibre-glass 1.50 mm
- Double-sided 35 µm Cu
- Plated through holes (PTH)
- Surface chem. Ni/Au
- Solder stop mask
- Adaption circuit board for SOP56 & HSOP56 with 0.635 mm pitch
- Hole spacing 2.54 mm
- Hole diameter Ø 1.10 mm with solder pads Ø 2.20 mm
- Two experimenting areas with 8 x 8 square pads 2.20 x 2.20 mm
- Shield pad & cooling pad
- Size 73.66 x 43.18 mm